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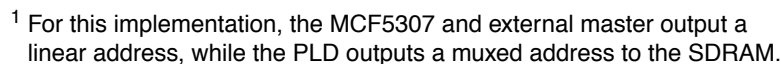
This application note discusses the issues involved in designing external logic that allows the ColdFire® processor's on-chip SDRAM controller to work with external masters. Although this document specifically refers to the MCF5307, it can be used to design an external master-to-SDRAMC interface for the MCF5407 as well, since the SDRAMC modules are the same.

This document assumes familiarity with the MCF5307 SDRAMC and working knowledge of the initialization sequence required for proper SDRAM operation. For the purposes of this application note, it is assumed that all SDRAM accesses are aligned and non-bursting. Refer to the *MCF5307 User's Manual* (MCF5307UM/D) and *Using the SDRAM Controller on the MCF5307 ColdFire Integrated Processor Application Note* (AN1766/D) for more information.

1.1   Overview

The block diagram in Figure 1 shows the connections between the MCF5307, PLD, SDRAM, and the external master.

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[1] For this implementation, the MCF5307 and external master output a
linear address, while the PLD outputs a muxed address to the SDRAM.

Figure 1. Block Diagram

Once the external master is granted control of the bus, it initiates an SDRAM access by asserting either $\overline{TS}$ or $\overline{AS}$ (only one signal can be used). The external master also needs to drive the linear address, data (if a write cycle), SIZ[1:0], and R/$\overline{W}$. Once the assertion of $\overline{TS}$ or $\overline{AS}$ alerts the MCF5307 to the beginning of a new bus cycle, the processor latches the address, SIZ[1:0], and R/$\overline{W}$ signals to determine what type of bus cycle is starting.

If the address hits in SDRAM space, the MCF5307 drives the SDRAM control signals ($\overline{SRAS}$, $\overline{SCAS}$, $\overline{DRAMW}$, SCKE (CMD), $\overline{RAS}$, and $\overline{CAS}$).

The PLD's primary responsibility is to detect SDRAM bus cycles and generate the correct muxed address to the SDRAM. This means that the PLD needs to distinguish between an SDRAM access and an SDRAM command, such as a refresh cycle. During read or write accesses the PLD needs to handle address muxing and $\overline{TA}$ generation, but during other SDRAM commands the PLD should just pass the SDRAM control signals generated by the MCF5307 through to the SDRAM.

1.2 SDRAM Overview

One of the main differences between synchronous and asynchronous DRAM is the use of commands to control the memory's state machine. During every clock cycle, the SDRAM latches in a new command based on the encoding of the address and control lines. Table 1 lists all of the SDRAM commands that are used by the MCF5307 SDRAM controller and the encoding of the ColdFire SDRAM control signals for the associated command.

Table 1. SDRAM Commands Truth Table

Command	Description	$\overline{RAS}$	$\overline{SRAS}$	$\overline{SCAS}$	R/$\overline{W}$	SCKE (CMD)
ACTV	Decode row address	L [1]	L	H [2]	H	V [3]
MRS	Mode register set	L	L	L	L	L
NOP	No operation	L	H	H	H	X [4]
PALL	Precharge all	L	L	H	L	H
READ	Read access	L	H	L	H	L
REF	Auto refresh	L	L	L	H	X
WRITE	Write access	L	H	L	L	L

[1] L = Low
[2] H = High
[3] V = Valid
[4] X = Don't care

1.3 MCF5307 Signals

Table 2 describes the MCF5307 signals used to interface to the SDRAM and external master.

Table 2. MCF5307 Signals

Signal Name	Signal Description
SDRAMC Signals	
$\overline{SRAS}$	Synchronous row address strobe. Indicates a valid row address can be latched by the SDRAM. Connects to SDRAM $\overline{RAS}$ input.
$\overline{SCAS}$	Synchronous column address strobe. Indicates a valid column address can be latched by the SDRAM. Connects to SDRAM $\overline{CAS}$ input.
$\overline{DRAMW}$	DRAM write. Indicates direction of data transfer for SDRAM cycles: • High indicates a read • Low indicates a write
SCKE	Synchronous clock enable. Enables SDRAM's self-refresh mode. When external multiplexing is used, DCR[COC] allows the SCKE signal to provide command bit data for the SDRAM.

Table 2. MCF5307 Signals (continued)

Signal Name	Signal Description
$\overline{\text{RAS}}$[1:0]	Row address strobe. Used to select one of the two possible blocks of SDRAM that can be connected to the MCF5307. The $\overline{\text{RAS}}$ signals should be connected to the chip select input of the SDRAM.
$\overline{\text{CAS}}$[3:0]	Column address strobe. For SDRAM, the $\overline{\text{CAS}}$ signals function as byte enables. They should be connected to the DQM pins of the SDRAM.
Bus Signals	
BCLKO	Bus clock output. System bus clock output from the MCF5307.
Address[31:0]	32-bit address bus.
Data[31:0]	32-bit data bus.
$\overline{\text{TS}}$ or $\overline{\text{AS}}$	Transfer start or address strobe. During external master bus cycles one of these signals must be asserted to alert the MCF5307 to the start of a new bus cycle.
R/$\overline{\text{W}}$	Read/write. Indicates direction of data transfer: • High indicates a read • Low indicates a write
SIZ	Size. Encoded signals that indicate longword, byte, word, or line transfer.
Bus Arbitration Signals	
$\overline{\text{BG}}$	Bus grant. Input to MCF5307 asserted to indicate that the MCF5307 can take mastership of the bus.
$\overline{\text{BD}}$	Bus driven. Output from MCF5307 indicating that it is the current bus master and is driving the bus.
$\overline{\text{BR}}$	Bus request. Output from MCF5307 to external master or arbiter to indicate that the MCF5307 requests bus mastership for one or more bus cycles.

1.4   The PLD Outputs

This section discusses each of the PLD outputs and explains how they are generated.

1.4.1 $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, and $\overline{\text{WE}}$

These signals are duplicates of the $\overline{\text{SRAS}}$, $\overline{\text{SCAS}}$, and $\overline{\text{DRAMW}}$ signals output by the MCF5307. The only difference between the outputs of the PLD and the MCF5307 is that the PLD adds additional delay on the signals. Care should be taken to ensure that this additional delay will not cause any timing conflicts. The EDGESEL module can help compensate for the additional delay on the control signals; see Section 11.4.2, "Using Edge Select (EDGESEL)," in the *MCF5307 User's Manual* for more information.

1.4.2   Address

The primary function of the PLD is to generate the muxed row and column addresses for the SDRAM. The SDRAM uses a two-phase address (a row and a column address) to access a single memory location. The row address is latched during an ACTV command, and the column address is latched during READ or WRITE commands (see Table 1 on page 3). Each is latched by the SDRAM during the appropriate address strobe ($\overline{\text{SRAS}}$ and $\overline{\text{SCAS}}$). Any method can be used to generate the muxing solution, including the muxing algorithm already implemented by the MCF5307 SDRAMC.

1.4.2.1   Muxing Example 1

In some cases it might be easiest to implement the same muxing scheme as used when the MCF5307 is handling the address muxing. For more information, refer to the address multiplexing tables in Section 11.4.4.1, "Address Multiplexing," in the *MCF5307 User's Manual*.

For example, use the muxing shown in Table 3 when connecting to a 16-bit wide SDRAM port with 9 column addresses, 11 row addresses, and 2 bank selects.

Table 3. ColdFire SDRAM Muxing Algorithm Example

SDRAM Address Pin	Linear Address Signal Driven during $\overline{SRAS}$ [1]	Linear Address Signal Driven during $\overline{SCAS}$ [1]
A0	A16	A1
A1	A15	A2
A2	A14	A3
A3	A13	A4
A4	A12	A5
A5	A11	A6
A6	A10	A7
A7	A9	A8
A8	A18	A17
A9	A20	A19
A10	A21	SCKE (CMD)
A11	A22	—
BA0	A23	—
BA1	A24	—

[1]   The linear address signals listed correspond to the physical address pin on the MCF5307.

1.4.2.2   Muxing Example 2

Using external logic to handle the address line muxing for all SDRAM bus cycles allows for any valid muxing scheme to be used. Since the muxing scheme used by the SDRAMC is somewhat complicated, a simpler muxing algorithm, such as that shown in Table 4, can be used instead.

Table 4. Alternate SDRAM Muxing Algorithm

SDRAM Address Pin	Linear Address Signal Driven during $\overline{SRAS}$ [1]	Linear Address Signal Driven during $\overline{SCAS}$ [1]
A0	A1	A13
A1	A2	A14
A2	A3	A15
A3	A4	A16
A4	A5	A17
A5	A6	A18

Table 4. Alternate SDRAM Muxing Algorithm (continued)

SDRAM Address Pin	Linear Address Signal Driven during $\overline{SRAS}$ [1]	Linear Address Signal Driven during $\overline{SCAS}$ [1]
A6	A7	A19
A7	A8	A20
A8	A9	A21
A9	A10	A22
A10	A11	SCKE
A11	A12	—
BA0	A23	—
BA1	A24	—

[1] The linear address signals listed correspond to the physical address pin on the MCF5307.

1.4.3   CMD/AP/A10

The command (CMD) bit (also known as auto-precharge(AP) or A10 of the SDRAM) is a specialized address line input to the SDRAM. During a row address phase, this signal is used as a bit in the row address, but, at other times, it is used to indicate specific SDRAM commands to be processed. Setting the COC bit in the DRAM control register (DCR) allows the MCF5307 to drive the command data on the SCKE line instead of driving the command on one of the address lines. So, the data from the SCKE line should be output on the PLD's CMD output most of the time, but during an $\overline{SRAS}$ strobe (ACTV) the output is an address signal.

1.4.4   Transfer Acknowledge

The $\overline{TA}$ timing is not consistent for external master SDRAM accesses, so the PLD must be used to generate an external $\overline{TA}$ that can be routed to the external master (see device errata #23 in *Errata to MCF5307* (document number: MCF5307ER/D) for more information). Consider 2 basic cases—writes and reads. For a write cycle, the data is latched by the SDRAM at the same time as the column address, as shown in Figure 2; however, the SDRAMC must execute a PALL to close the current memory page. Therefore, $\overline{TA}$ should be asserted during the PALL command.

NOTE

The signal names used in Figure 2 and Figure 3 are the MCF5307 signal names NOT the signal names used by the SDRAM. For example, the $\overline{RAS}$ signal in the timing diagram refers to the MCF5307 $\overline{RAS}$ lines which connect to the SDRAM chip selects.
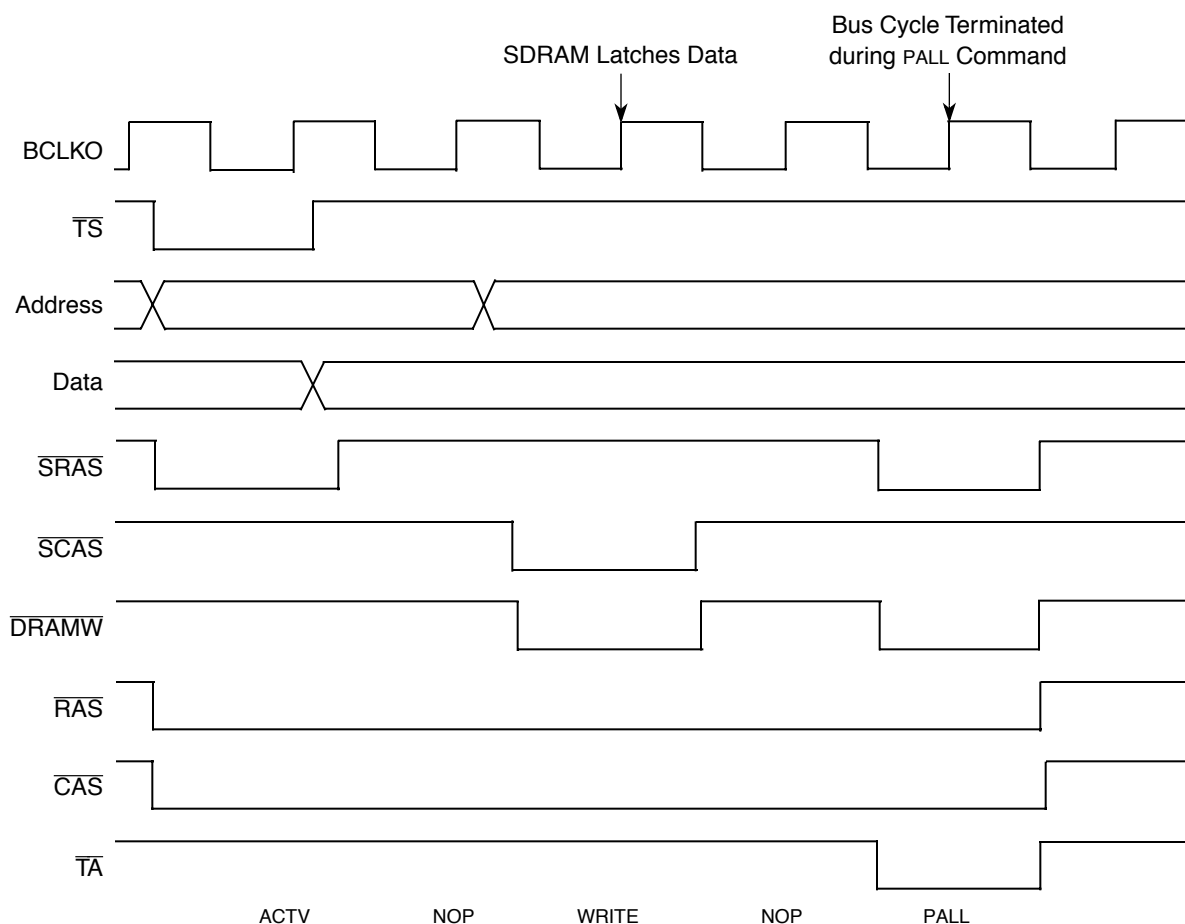
Figure 2. SDRAM Write Cycle Termination Timing

During read cycles there is a delay between when the column address is latched and when the data becomes available known as CAS latency (given in bus clocks). So for read cycles, once the PLD detects the end of the column address phase, it then needs to wait the same number of clocks as the CAS latency before terminating the bus cycle as shown in Figure 3.
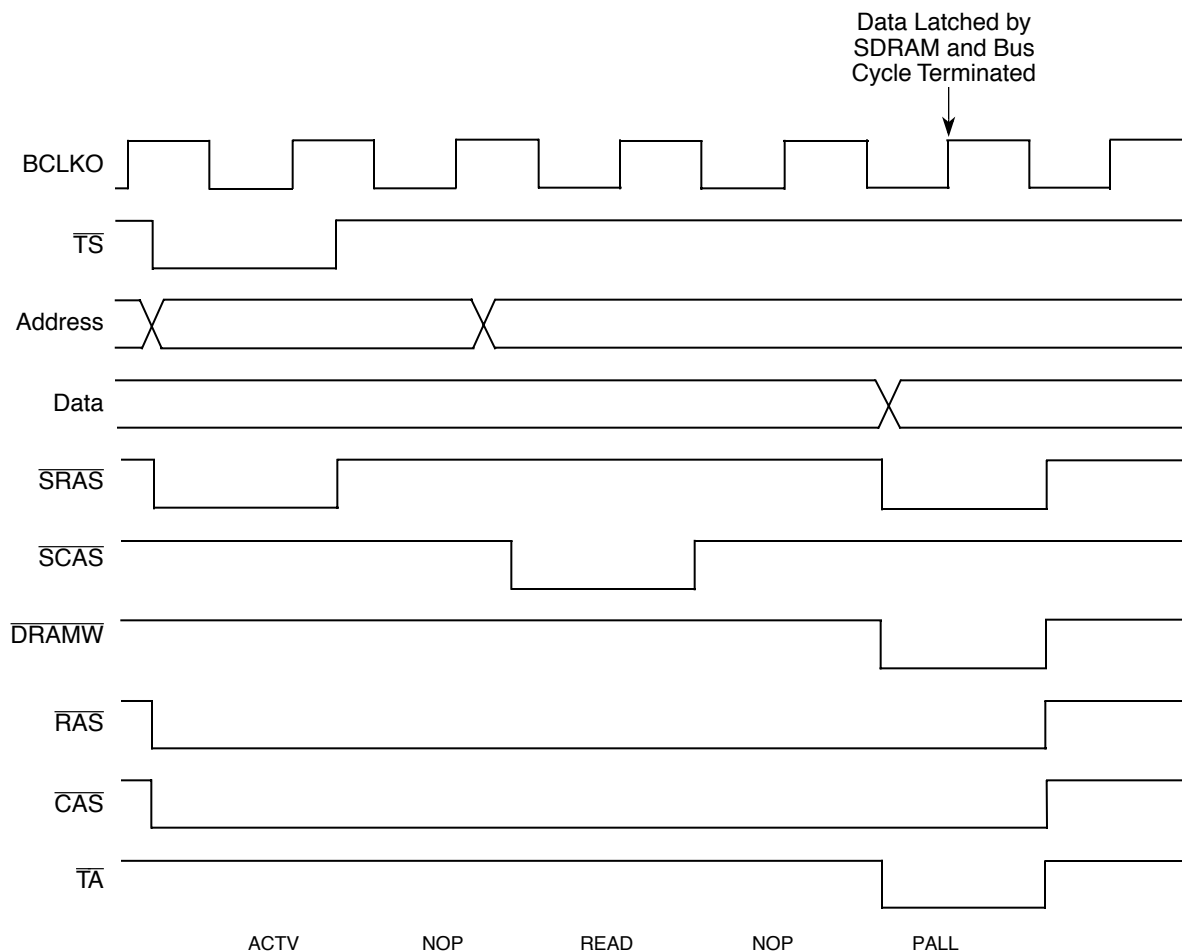

Figure 3. SDRAM Read Cycle Termination Timing

1.4.5   PLD Operation during SDRAM Commands

During all commands, the PLD should drive the $\overline{SRAS}$, $\overline{SCAS}$, and $\overline{DRAMW}$ on the $\overline{RAS}$, $\overline{CAS}$, and $\overline{WE}$ outputs of the PLD. Table 5 describes the effect of each SDRAM command on PLD operation.

Table 5. PLD Operation During SDRAM Commands

Command	PLD Operation
ACTV	Row address strobe and bank activation. During the ACTV command the SDRAM latches the row address. The PLD should drive the row address for the selected muxing algorithm.
MRS	Mode register set command. Sets the mode register physically located on the SDRAM chip(s). The mode register controls some of the timing and mode options for the SDRAM including the CAS latency. This command is unique in that the data written to the mode register is latched from the address lines. This means that the data to be written to the mode register must be mapped onto the address lines. Refer to Section 11.5.5, "Mode Register Initialization," in the MCF5307 User's Manual for an example on how to determine the correct address to use during the mode register set command.
NOP	No operation. The PLD does not need to do anything.
PALL	Precharge all. Closes the current SDRAM page, so next access starts with an ACTV command. PLD needs to drive command data from the SCKE line onto A10 of the SDRAM.
READ	Read. The column address to be read is latched by SDRAM. PLD should drive the column address for the selected muxing algorithm and drive command data from SCKE line onto the SDRAM's CMD pin. The READ command should also start the PLD counter responsible for generating the $\overline{TA}$.
REF	Refresh. Periodic refresh is required to retain data stored in SDRAM. PLD should pass through SDRAM control signals.

1.5 Programming the MCF5307 SDRAMC

This application note is not intended to address the settings and procedures for programming the SDRAMC; however, it is useful to note that the DRAM control register (DCR) should be configured with the no address multiplexing (NAM) and command-on-SDRAM clock enable (COC) bits both set. The NAM bit turns off the MCF5307's internal muxing capability so that all address muxing is handled by the PLD. The COC bit enables the SDRAMC to place the command bit information for the SDRAM on the SCKE line. The PLD drives the command data from SCKE onto the SDRAM's A10 address line. Since the SCKE signal is used to provide the SDRAM's command bit data, the self-refresh low-power mode is not available with this implementation. The CKE signal on the SDRAM should be tied high to disable the self-refresh mode.

For more information on initializing the SDRAM see the SDRAM section of the *MCF5307 User's Manual*.

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